DISPLAYTRONIC

SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY

AGM2412A SERIES GRAPHIC MODULE VER1.3

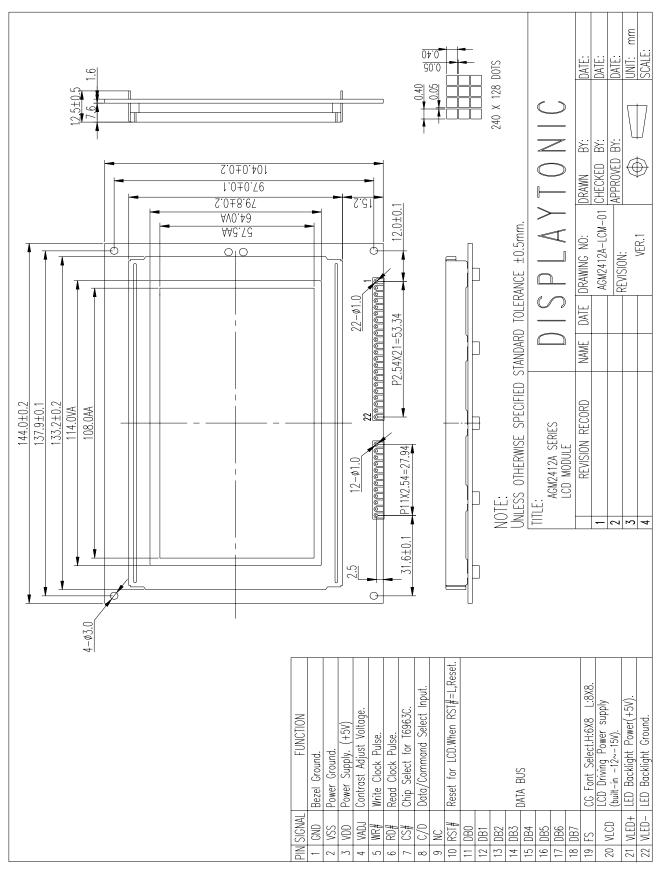
	CUSTOMER A	PPROVAL	
※ PART NO. :			
APPROVAL		COMPANY CHOP	
CUSTOMER COMMENTS			

DISPLAYTRONIC ENGINEERING APPROVAL									
DESIGN BY CHECKED BY APPROVED									

REVISION	RECORD		
REVISION	REVISION DATE	PAGE	CONTENTS
VER1.1	15/6-2006		MODIFY THE COVER,ADD CONTENT AND REVISION RECORD.
VER1.2	01/08-2006		TO CORRECT THE MECHANICAL DIAGRAM.
VER1.2	21/08-2006		THE PIN-LOCATION SHOULD REVISED TO THAT OF PHYSICAL SAMPLE(THE DRAWING IS INCORRECTIVE)
VER 1.3	09/01-2007		ADD PRECAUTION FOR USING LCM

※ CONTENTS

1.0 MECHANICAL DIAGRAM 2.0 GENERAL SPECIFICATION 3.0 ABSOLUTE MAXIMUM RATINGS 4.0 ELECTRICAL CHARACTERISTICS 5.0 OPTICAL CHARACTERISTICS 6.0 BLOCK DIAGRAM 7.0 PIN ASSIGNMENT 8.0 POWER SUPPLY 9.0 TIMING CHARACTERISTICS 10.0 RELIABILITY TEST 11.0 INSTRUCTION DESCRIPTION (T6963C) 12.0 PRECAUTION FOR USING LCM



1.0 MECHANICAL DIAGRAM

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2.0 MECHANICAL SPECS

1.	Overall Module Size	144.0mm(W) x 104.0mm(H) x max 12.5mm(D) for LED backlight version
2.	Dot Size	0.40mm(W) x 0.40mm(H)
3.	Dot Pitch	0.45mm(W) x 0.45mm(H)
4.	Duty	1/128
5.	Controller IC	T6963C
6.	LC Fluid Options	STN, FSTN
7.	Polarizer Options	Reflective, Transflective, Transmissive
8.	Backlight Options	LED
9.	Temperature Range Options	Standard (0°C ~ 50°C), Wide (-20°C ~ 70°C)

3.0 ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min	Тур	Max	Unit
Operating temperature (Standard)	Тор	0	-	50	°C
Storage temperature (Standard)	Tst	-10	-	60	٥C
Operating temperature (Wide temperature)	Тор	-20	-	70	٥C
Storage temperature (Wide temperature)	Tst	-30	-	80	٥C
Input voltage	Vin	-0.3	-	Vdd+0.3	V
Supply voltage for logic	Vdd- Vss	-0.3	-	7.0	V
Supply voltage for LCD drive	Vdd- Vo	6	-	28	V

4.0 ELECTRICAL CHARACTERISTICS

ltem	Symbol	Condition	Min	Тур	Max	Unit
Input voltage (high)	Vih	H level	Vdd-2.2	-	Vdd	V
Input voltage (low)	Vil	L level	0	-	0.8	V
		-20°C	-	19.0	20.0	
Recommended LC Driving Voltage (Wide Temp)	Vdd -VADJ	0°C	-	18.3	-	V
voltage (vvide remp)		25⁰C	-	18.0	-	
		50°C	-	17.8	-	
		70ºC	16.5	17.3	-	
Power Supply Current	ldd	Vdd=5.0V	-	20	25.0	mA
Powe Supply voltage for White LED	(VLED+)-VLED-	RL=12Ω	4.4	5.0	6.8	V
LED Power Supply Current	lfled	RL=12Ω	120	160	320	mA
Powe Supply voltage For yellow-green LED	(VLED+)-VLED-	RL=4Ω	4.8	5.0	5.8	V
LED Power Supply Current	lfled	RL=4Ω	150	200	400	mA

5.0 OPTICAL CHARACTERISTICS

	Item	Cr (Contra	ast Ratio)	θ (View	ing Angle)	φ (Vie	(Viewing Angle)		
		25	°C	2	5ºC	25ºC			
Mode		MIN.	TYP.	MIN	TYP.	MIN	TYP.		
	А	2.8	3.05	80°	85°	-	35°		
R	В	7.10	7.70	80°	85°	-	35°		
	С	-	-	-	-	-	-		
	А	2.49	2.99	80°	85°	-	35°		
S	В	7.05	7.55	80°	85°	-	35°		
	С	-	-	-	-	-	-		

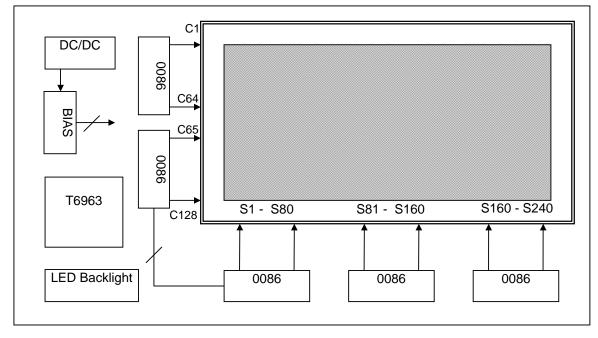
Note:

- R: Reflective S: Transflective A: STN Gray
- B: STN Yellow
- C: FSTN

At: $\phi = 0^\circ$, $\theta = 0^\circ$

ltem	Symbol	Condition	Min	Тур	Max	Unit
Response time (rise)	Tr	25 ⁰C	-	150	250	ms
Response time (fall)	Tf	25ºC	-	150	250	ms

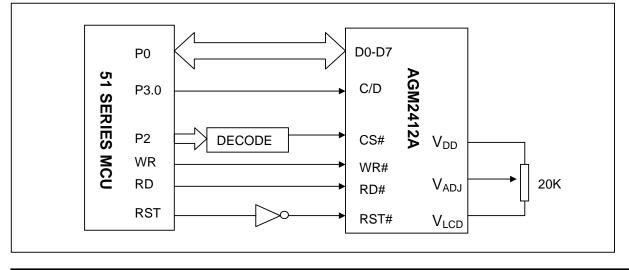
6.0 BLOCK DIAGRAM



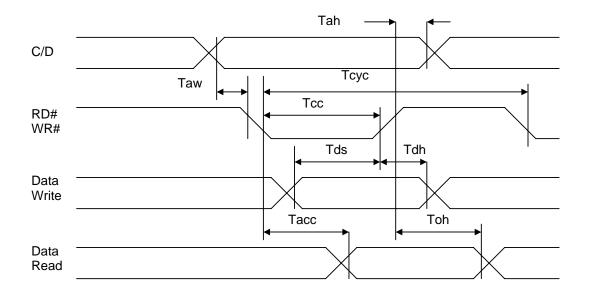
7.0 PIN ASSIGNMENT

Pin No.	Symbol	Function	Level
1	FGND	Frame Ground	-
2	V _{SS}	Ground	-
3	V _{DD}	+5V	-
4	VADJ	Contrast Adjust Voltage	-
5	/WR	H: Data read	L
		L: Data write	
6	/RD	Enable signal	L
7	/CE	Chip Enable	L
8	C/D	Command/Data	L/H
9	NC -		-
10	/RES	Reset	H/L
11	DB0	Data bit 0	H/L
12	DB1	Data bit 1	H/L
13	DB2	Data bit 2	H/L
14	DB3	Data bit 3	H/L
15	DB4	Data bit 4	H/L
16	DB5	Data bit 5	H/L
17	DB6	Data bit 6	H/L
18	DB7	Data bit 7	H/L
19	FS	Font Select	H/L
20	VLCD	Power supply for LCD driving	-15.0V
21	VLED+	Power supply for LED+	5.0V
22	VLED-	Power supply for LED-	0V

8.0 APPLICATION



9.0 TIMING CHARACTERISTICS



ITEM	SYMBLE	MIN	MAX	UNIT
Address Setup Time	Taw	10		ns
Address Hold Time	Tah	10		ns
RD#,WR# Cycle	Тсус	200		ns
RD#,WR# Pulse Width	Tcc	80		ns
Data Setup Time	Tds	80		ns
Data Hold Time (Write)	Tdh	40		ns
Data Access Time	Tacc		150	ns
Data Hold Time (Read)	Toh	10	50	ns

10.0 RELIABILITY TEST

		Evaluations and Assessment*							
Storage Condition	Content	Current Consumption	Oozing	Contrast	Other Appearances				
Operation at high temperature and humidity	40 º C,90% RH,240hrs	Twice initial value or less	none	More than 80% of initial value	No abnormality				
High temperature storage	60 º C, 240hrs	Twice initial value or less	none	More than 80% of initial value	No abnormality				
Low temperature storage	-20 ⁰C, 240hrs	Twice initial value or less		More than 80% of initial value	No abnormality				

*Evaluations and assessment to be made two hours after returning to room temperature (25°C±5°C).

*The LCDs subjected to the test must not have dew condensation.

11.0 DISPLAY CONTROL INSTRUCTION

The display control instructions control the internal state of the T6963c.

COMMANIE	Cor	ntrol S	tate	Code								DESCRIPTION
COMMAND	CD	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION
REGISTERS SETTIBG	1	1	0	0	0	1	0	0	N2	N1	N0	N2N1N0001Set Cursor Pointer010Set Offset Register100Set address Pointer
SET CONTROL WORD	1	1	0	0	1	0	0	0	0	N1	NO	 N1 N0 0 Set Text Home Address 1 Set Text Area 2 0 Set Graphic Home Address 1 Set Graphic Area
MODE SET	1	1	0	1	0	0	0	C G	N2	N1	NO	CG=0: Internal CG ROM Mode CG=1: Internal CG ROM Mode N2 N1 N0 Graphic & Text 0 0 0 OR Mode 0 0 1 Exor Mode 0 1 1 And Mode 1 0 0 Text Attribute Mode
DISPLAY MODE	1	1	0	1	0	0	1	N3	N2	N1	NO	N3=0: Display Off N3=1: Display On N2=0:Text Off N2=1: Text On N1=0: Cursor Off N1=1: Cursor On N0=0: Blink Off N0=1: Blink On
CURSOR PATTERN SELECT	1	1	0	1	0	1	0	0	N2	N1	NO	N2,N1,N0 Line Number of Cursor N2 N1 N0 0 0 01-Line Cursor (Bottom Line) 1 1 18-Line Cursor (8x8Dots)
DATA AUTO READ/WRITE	1	1	0	1	0	1	1	0	0	N1	N0	N1N000Data Auto Write01Data Auto Read1*Auto Reset
DATA READ/WRITE	1	1	0	1	1	0	0	0	N2	N1	NO	N2=0: ADP Variable N2=1: ADP Nonvariable N1=0: Increment ADP N1 =1: Decrement ADP N0=0: Data Write N0=1: Data Read
SCREEN PEEK	1	1	0	1	1	1	0	0	0	0	0	Screan Peek
SCREEN COPY	1	1	0	1	1	1	0	1	0	0	0	Screen Copy
BIT SET/RESET	1	1	0	1	1	1	1	N3	N2	N1	N0	N3=0: Bit Reset N3=1: Bit Set N2, N1, N0 Bit Address 000-D0, 111-D7
DATA WRITE	0	1	0		Write Data						Writes data DB0~DB7 into display data RAM. After writing instruction	
DATA READ	0	0	1			I	Read	Data	a			Reads data DB0~DB7 from display data RAM to the data bus.

12.0PRECAUTION FOR USING LCM

- 1. When design the product with this LCD Module, make sure the viewing angle matches to its purpose of usage.
- 2. As LCD panel is made of glass substrate, Dropping the LCD module or banging it against hard objects may cause cracking or fragmentation. Especially at corners and edges.
- 3. Although the polarizer of this LCD Module has the anti-glare coating, always be careful not to scratch its surface. Use of a plastic cover is recommended to protect the surface of polarizer.
- 4. If the LCD module is stored at below specified temperature, the LC material may freeze and be deteriorated. If it is stored at above specified temperature, the molecular orientation of the LC material may change to Liquid state and it may not revert to its original state. Excessive temperature and humidity could cause polarizer peel off or bubble. Therefore, the LCD module should always be stored within specified temperature range.
- 5. Saliva or water droplets must be wiped off immediately as those may leave stains or cause color changes if remained for a long time. Water vapor will cause corrosion of ITO electrodes.
- 6. If the surface of LCD panel needs to be cleaned, wipe it swiftly with cotton or other soft cloth. If it is not still clean enough, blow a breath on the surface and wipe again.
- 7. The module should be driven according to the specified ratings to avoid malfunction and permanent damage. Applying DC voltage cause a rapid deterioration of LC material. Make sure to apply alternating waveform by continuous application of the M signal. Especially the power ON/OFF sequence should be kept to avoid latchup of driver LSIs and DC charge up to LCD panel.
- 8. Mechanical Considerations
 - a) LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.
 - b) Do not tamper in any way with the tabs on the metal frame.
 - c) Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
 - d) Do not touch the elastomer connector; especially insert a backlight panel (for example, EL).
 - e) When mounting a LCM makes sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
 - f) Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.
- 9. Static Electricity
- a) Operator

Ware the electrostatics shielded clothes because human body may be statically charged if not ware shielded clothes. Never touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.

b) Equipment

There is a possibility that the static electricity is charged to the equipment, which has a function of peeling or friction action (ex: conveyer, soldering iron, working table). Earth the equipment through proper resistance (electrostatic earth: $1x10^8$ ohm).

Only properly grounded soldering irons should be used.

If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks. The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

c) Floor

Floor is the important part to drain static electricity, which is generated by operators or equipment.

There is a possibility that charged static electricity is not properly drained in case of insulating floor. Set the electrostatic earth (electrostatic earth: 1x10⁸ ohm).

d) Humidity

Proper humidity helps in reducing the chance of generating electrostatic charges. Humidity should be kept over 50%RH.

e) Transportation/storage

The storage materials also need to be anti-static treated because there is a possibility that the human body or storage materials such as containers may be statically charged by friction or peeling.

The modules should be kept in antistatic bags or other containers resistant to static for storage.

f) Soldering

Solder only to the I/O terminals.Use only soldering irons with proper grounding and no leakage. Soldering temperature : 280° C \pm 10° C Soldering time: 3 to 4 sec. Use eutectic solder with resin flux fill. If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed afterwards.

g) Others

The laminator (protective film) is attached on the surface of LCD panel to prevent it from scratches or stains. It should be peeled off slowly using static eliminator.

Static eliminator should also be installed to the workbench to prevent LCD module from static charge.

10. Operation

- a) Driving voltage should be kept within specified range; excess voltage shortens display life.
- b) Response time increases with decrease in temperature.
- c) Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
- d) Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".
- 11. If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. The toxicity is extremely low but caution should be exercised at all the time.
- 12. Disassembling the LCD module can cause permanent damage and it should be strictly avoided.
- 13. LCD retains the display pattern when it is applied for long time (Image retention). To prevent image retention, do not apply the fixed pattern for a long time. Image retention is not a deterioration of LCD. It will be removed after display pattern is changed.
- 14. Do not use any materials, which emit gas from epoxy resin (hardener for amine) and silicone adhesive agent (dealcohol or deoxym) to prevent discoloration of polarizer due to gas.

15. Avoid the exposure of the module to the direct sunlight or strong ultraviolet light for a long time. The brightness of LCD module may be affected by the routing of CCFL cables due to leakage to the chassis through coupling effect. The inverter circuit needs to be designed taking the level of leakage current into consideration. Thorough evaluation is needed for LCD module and inverter built into its host equipment to